

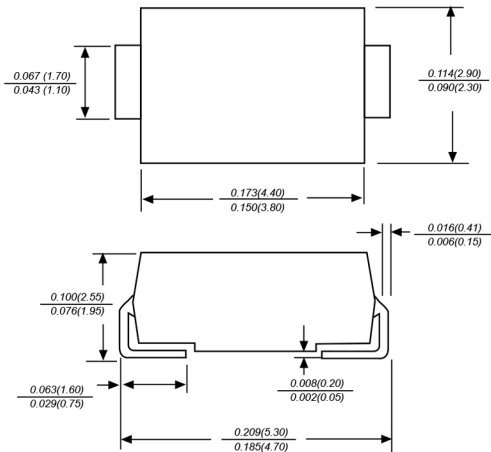
FEATURES

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Super fast switching for high efficiency
- ◆ Low reverse leakage
- ◆ Built-in strain relief, ideal for automated placement
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed: 260°C/10 seconds at terminals

MECHANICAL DATA

Case: JEDEC DO-214AC molded plastic body
Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
Polarity: Color band denotes cathode end
Mounting Position: Any
Weight: 0.002 ounce, 0.07 grams

DO-214AC



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

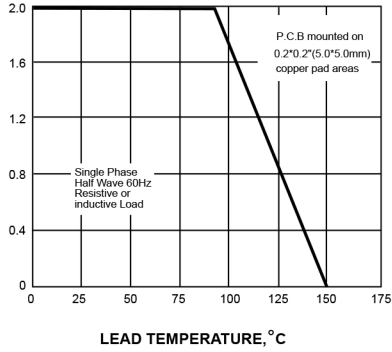
Ratings at 25°C ambient temperature unless otherwise specified.
 Single phase half wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

	SYMBOLS	ES2A	ES2B	ES2C	ES2D	ES2E	ES2G	ES2J	UNITS	
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	150	200	300	400	600	V	
Maximum RMS voltage	V_{RMS}	35	70	105	140	210	280	420	V	
Maximum DC blocking voltage	V_{DC}	50	100	150	200	300	400	600	V	
Maximum average forward rectified current at $T_L=90^\circ\text{C}$	$I_{(AV)}$	2.0							A	
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	30.0							A	
Maximum instantaneous forward voltage at 1.0A	V_F	0.95				1.25		1.7	V	
Maximum DC reverse current $T_A=25^\circ\text{C}$ at rated DC blocking voltage $T_A=100^\circ\text{C}$	I_R	5.0				50.0				μA
Maximum reverse recovery time (NOTE 1)	t_{rr}	35				ns				
Typical junction capacitance (NOTE 2)	C_J	15.0				pF				
Typical thermal resistance (NOTE 3)	$R_{\theta JA}$	70.0				$^\circ\text{C/W}$				
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150							$^\circ\text{C}$	

Note: 1. Reverse recovery condition $I_F=0.5\text{A}, I_R=1.0\text{A}, I_{rr}=0.25\text{A}$
 2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
 3. P.C.B. mounted with 0.2x0.2" (5.0x5.0mm) copper pad areas

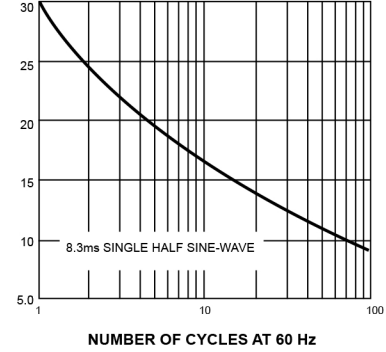
AVERAGE FORWARD RECTIFIED CURRENT,
AMPERES

FIG. 1- FORWARD CURRENT DERATING CURVE



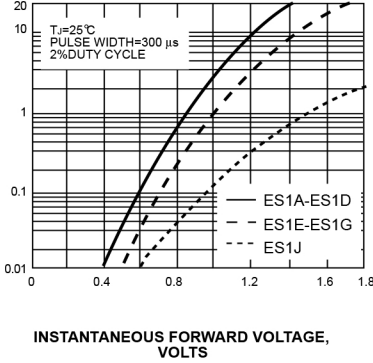
PEAK FORWARD SURGE CURRENT,
AMPERES

FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT



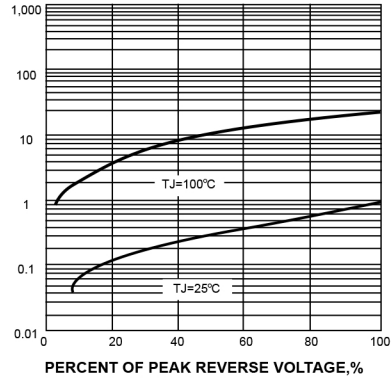
INSTANTANEOUS FORWARD CURRENT,AMPERES

FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS



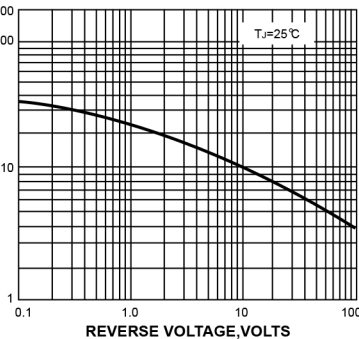
INSTANTANEOUS REVERSE CURRENT,
MICROAMPERES

FIG. 4-TYPICAL REVERSE CHARACTERISTICS



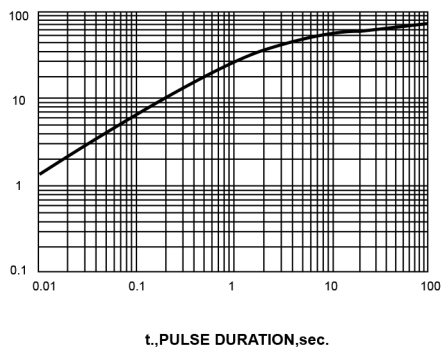
JUNCTION CAPACITANCE, pF

FIG. 5-TYPICAL JUNCTION CAPACITANCE



TRANSIENT THERMAL IMPEDANCE,
°C/W

FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE



单击下面可查看定价，库存，交付和生命周期等信息

[>>RCD\(达标电子\)](#)